Notification about the transfer of the semiconductor business

The semiconductor business of Panasonic Corporation was transferred on September 1, 2020 to Nuvoton Technology Corporation (hereinafter referred to as "Nuvoton"). Accordingly, Panasonic Semiconductor Solutions Co., Ltd. became under the umbrella of the Nuvoton Group, with the new name of Nuvoton Technology Corporation Japan (hereinafter referred to as "NTCJ").

In accordance with this transfer, semiconductor products will be handled as NTCJ-made products after September 1, 2020. However, such products will be continuously sold through Panasonic Corporation.

Publisher of this Document is NTCJ.

If you would find description "Panasonic" or "Panasonic semiconductor solutions", please replace it with NTCJ.

Except below description page
 "Request for your special attention and precautions in using the technical information and semiconductors described in this book"

Nuvoton Technology Corporation Japan

Doc No. TD4-EA-01881 Revision. 1

Panasonic _____

MIP0040MFL

Туре	Silicon MOSFET type Integrated Circuit			
Application	For Switching Power Supply Control			
Structure	CMOS type			
Equivalent Circuit	Figure 8			
Package	SO8-G2-B Marking MIP004			

A. ABSOLUTE MAXIMUM RATINGS (Ta=25°C±3°C)

NO.	Item	Symbol	Ratings	Unit	
1	VIN Voltage				
		VIN	−0.3 ~ 500	V	
2	VCC Voltage				
		VCC	−0.3 ~ 45	V	
3	VDD Voltage				
		VDD	−0.3 ~ 9	V	
4	OUT Voltage				
		VOUT	−0.3 ~ 30	V	
5	IS Voltage				
		VIS	−0.3 ~ 5	V	
6	TR Voltage				
		VTR	10	V	
7	TR Current				
		ITR	— 5	mA	
8	Channel Temperature				
		Tch	150	°C	
9	Storage Temperature				
		Tstg	$-55 \sim +150$	°C	

B. RECOMMENDED OPERATING CONDITIONS

NO.	Ītem	Symbol	Conditions	Unit	Note
1	Junction Temperature				
		Tj	−40 ~ +125	လူ	

C. ELECTRICAL CHARACTERISTICS Me	asure condition (Ta=25°C±3°C)
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No.	Item	Symbol	Measure Condition (Figure 1)	Тур.	Min.	Max.	Unit
[CONT	【CONTROL FUNCTIONS】 *Design guaranteed item						
1	VCC Start Voltage						
		VCC(ON)		20	18	22	V
2	VCC Stop Voltage						
		VCC(OFF)		13	12	14	٧
3	VCC Start/Stop Hysteresis		V00(0H) V00(0FF)				
		D_VCC	VCC(ON) - VCC(OFF)	7	6	8	V



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C. ELE	ECTRICAL CHARACTERISTICS Me	asure conditi	on(Ta=25°C±3°C)				
No.	Item	Symbol	Measure Condition (Figure 1)	Тур.	Min.	Max.	Unit
4	VDD Start Voltage	VDD(ON)		6.0	5.4	6.6	V
5	VDD Stop Voltage	VDD(OFF)		4.8	4.3	5.3	٧
6	VDD Clamp Voltage	VDD(CLP)	IDD = 5 mA	6.7	5.9	7.5	٧
7	VDD Control Voltage	VDD(CNT)	ON → OFF	5.7	5.1	6.3	V
8	VDD Control Hysteresis	VDDCNTHYS	OFF → ON	10	_	-	mV
9	VDD Start/Stop Hysteresis	D_VDD1	VDD(ON) – VDD(OFF)	1.2	0.9	1.5	V
10	Deference between VDD(ON) and VDD(CNT)	D_VDD2	VDD(ON) - VDD(CNT)	0.3	0.05	0.6	V
11	Deference between VDD(CNT) and VDD(OFF)	D_VDD3	VDD(CNT) - VDD(OFF)	0.9	0.6	1.2	٧
12	Deference between VDD(ON) and VDD(CNT)	D_VDD4	VDD(CLP) - VDD(CNT)	1.0	0.6	1.4	٧
13	VCC Current at Start-up	ICC(SB)	VCC = VCC(ON) - 0.5 V, VDD = VDD(ON) + 0.2 V	0.18	0.08	0.18	mA
14	VCC Current at Off-state	ICC(OFF)	VCC = 15 V VDD = VDD(CNT) + 0.2 V	0.17	0.07	0.27	mA
15	VCC Current at Operating	ICC(OP)	VCC = 20V, COUT = 1nF, VDD = VDD(CNT) - 0.3 V	0.60	0.40	0.80	mA
16	VDD Current at Start-up	IDD(SB)	VCC = VDD(ON) + 0.5 V VDD = VDD(ON) - 0.2 V	0.63	0.52	0.77	mA
17	VDD Current at Off-state	IDD(OFF)	VCC = 15 V VDD = VDD(CNT) + 0.2 V	0.65	0.55	0.75	mA
18	VDD Current at Operating	IDD(OP)	VCC = 20V, VDD = VDD(CNT) - 0.3 V	0.58	0.46	0.70	mA
19	Output Frequency at Start-up	fosc		25	22	28	kHz
20	Jitter IS Voltage Deviation	D_VIS	VDD = VDD(CNT) - 0.1 V **Figure 2	32	_	_	mV
*21	Transformer Reset Voltage	VTH(TR)		65	5	125	mV
22	Transformer Reset Detection Delay Time	Td(TR)		150	_	_	ns
23	Mask Time after Turn-off at Heavy Load	Td(OFF)1	VDD = VDD(CNT) - 0.3 V **Figure 3	5	_	_	μs
24	Mask Time after Turn-off at Light Load	Td(OFF)2	VDD = VDD(CNT) **Figure 3	12	_	_	μs
25	VCC Charge Current	ICCH1	VCC = 0 V, VDD = open, VIN = 50 V	-9.0	-13.0	-5.4	mA
		ICCH2	VCC = 18 V, VDD = open, VIN = 50 V	-3.20	-5.00	-1.92	mA

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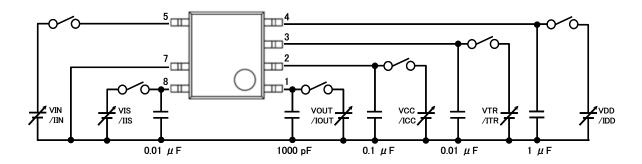
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C. ELE	CTRICAL CHARACTERISTICS Me	asure conditi	on (Ta=25°C±3°C)				
No.	Item	Symbol	Measure Condition (Figure 1)	Тур.	Min.	Max.	Unit
26	VDD Charge Current	IDCH1	VCC = VCC(ON), VDD = 0 V, VIN = 50 V	-25	-35	-15	mA
		IDCH2	VCC = VCC(ON), VDD = 5 V, VIN = 50 V	-20	-30	-10	mA
[CIRCI	JIT PROTECTIONS】 *Design guarantee	ed item					
27	Current Limit Detection Voltage	VLIMIT	VDD = VDD(CNT) - 0.3 V	800	744	856	mV
*28	Current Detection Voltage at Light Load	VIS(OFF)	VDD = VDD(CNT)	160	100	220	mV
29	Sense Offset Current at Heavy Load	IIS1	VDD = VDD(CNT) - 0.3 V, VIS = 0 V	0	-0.2	0.2	μΑ
30	Sense Offset Current at Light Load	IIS2	VDD = VDD(CNT), VIS = 0 V	-65	-	-	μΑ
31	Minimum On Time	Ton(MIN)	VCC = 20 V, COUT = 1 nF	700	-	-	ns
32	Maximum On Time	Ton(MAX)		26	22	30	μs
33	Current Limit Detection Delay	Td(OCL)		200	_	_	ns
34	Timer Intermittent Cycle	TIMER	VDD = VDD(ON) ⇔VDD(OFF), VIS > VLIMIT		8	l	_
35	VCC Overvoltage Protection Detection	VCC(OV)		34	31	37	V
36	TR Latch Threshold Voltage	VTH(LAT)		VDD-0.8	VDD-1.3	VDD-0.3	V
*37	TR Latch Detection Filter Time	Td(LAT)		120	70	170	μs
38	Latch Reset VDD Threshold	VDDreset		2.7	1.7	3.7	V
*39	Thermal Shutdown Temperature	ТОТР		140	130	150	°C
*40	Thermal Shutdown Temperature Hysteresis	TOTPHYS		70	-	_	°C
[OUTP	PUT】 *Design guaranteed item			•			
41	Output Sink Current	IOUTL	VCC = 20 V, VOUT = 12 V	0.45	_	_	Α
42	Output Source Current	IOUTH	VCC = 20 V, VOUT = 0 V	-0.22	-	-	Α
43	Low Level Output Voltage	VOUTL	VCC = 20 V, IOUT = 10 mA	0.1	-	0.3	V
*44	High Level Output Threshold Voltage	VOUT(TH)	※Figure 5	12.4	10.9	13.9	V
*45	High Level Output Minimum Voltage	VOUT(MIN)	VCC = VCC(OFF) ※Figure 6	9.9	9	11	V

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C. ELE	C. ELECTRICAL CHARACTERISTICS Measure condition (Ta=25°C±3°C)						
No.	Item	Symbol	Measure Condition (Figure 1)	Тур.	Min.	Max.	Unit
46	Rise Time	tr	VCC = 20 V, COUT = 1 nF ※Figure 7	275	_	_	ns
47	Fall Time	tf	VCC = 20 V, COUT = 1 nF	50	1	1	ns
【HIGH	VOLTAGE INPUT						
48	VIN pin OFF-State Leakage Current	IIN(LEAK)	VIN = 450 V, VCC > VCC(ON), VDD > VDD(ON)	5	_	20	μΑ
49	VIN pin Breakdown Voltage	BVVIN	IIN = 100 μ A, VCC > VCC(ON), VDD > VDD(ON)	-	500	-	V
50	Minimum VIN Supply Voltage	VIN(MIN)		28	23	33	V

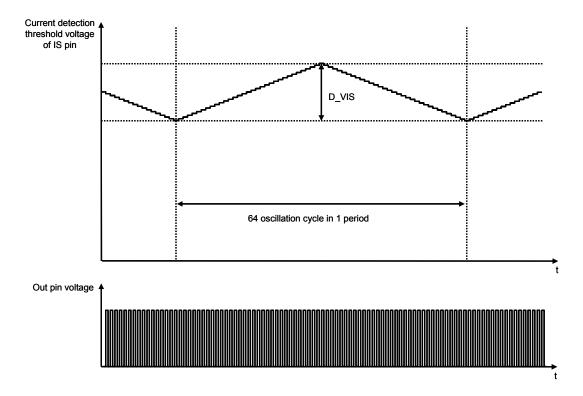
[Figure 1: Measure circuit/Pin Layout]



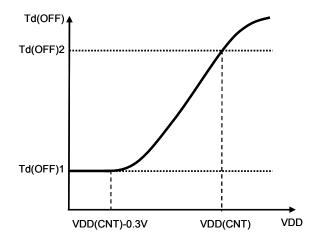
Pin No.	Pin Name
1	OUT
2	VCC
3	TR
4	VDD
5	VIN
6	_
7	GND
8	IS

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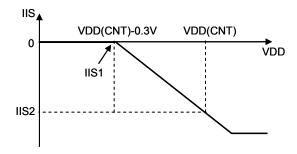
[Figure 2: D_VIS measurement]



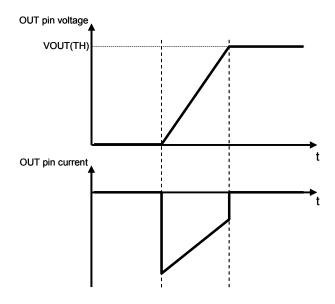
[Figure 3: VDD - Td(OFF) Characteristics]



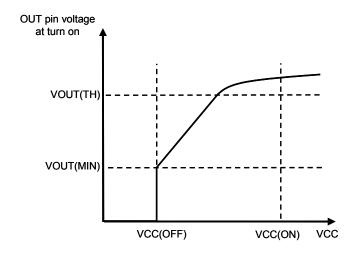
[Figure 4: VDD - IIS Characteristics]



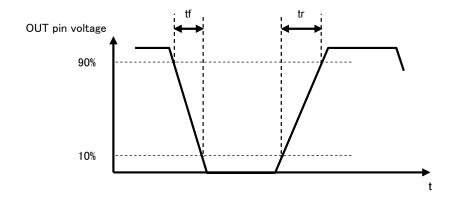
[Figure 5: VOUT(TH) measurement]



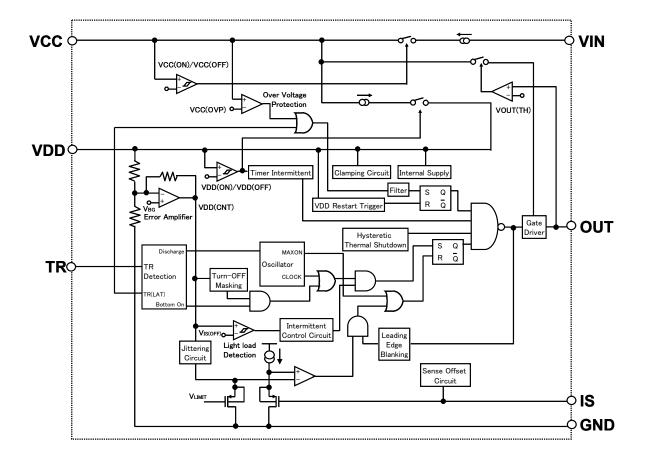
[Figure 6: VOUT(MIN) measurement]



[Figure 7: tr, tf measurement]



[Figure 8: Block Diagram]



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[Precautions for Use 1]

Connect a ceramic capacitor with value > 0.1 μ F between VDD pin and GND, and between VCC pin and GND.

[Precautions for Use 2]

The product has risks for break-down or burst or giving off smoke in following conditions. Avoid the following use. Fuse should be added at the input side or connect zener diode between control pin and GND, etc as a countermeasure to pass regulatory Safety Standard. Concrete countermeasure could be provided individually. However, customer should make the final judgment.

- (1) Reverse the VIN pin and OUT pin connection to the power supply board.
- (2) VIN pin short to OUT pin.
- (3) VIN pin short to VCC pin.
- (4) VIN pin short to TR pin.
- (5) VIN pin short to VDD pin.
- (6) VIN pin short to IS pin.
- (7) VCC pin short to TR pin.
- (8) VCC pin short to VDD pin.
- (9) VCC pin short to IS pin.

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